ASYNCHRONOUS SRAM

512K x 8 SRAM

+3.3V SUPPLY REVOLUTIONARY PINOUT

FEATURES

- Fast access times: 10, 12 and 15ns
- Fast OE# access times: 5, 6and 7ns
- Single +3.3V ±0.3V power supply
- Fully static -- no clock or timing strobes necessary
- All inputs and outputs are TTL-compatible
- Three state outputs
- Center power and ground pins for greater noise immunity
- JEDEC standard for functionality and revolutionary pinout

Ι

- Easy memory expansion with CE# and OE# options
- Automatic CE# power down
- High-performance, low-power consumption, CMOS double-poly, double-metal process

OPTIONS	MARKING					
Timing						
10ns access	-10					
12ns access	-12					
15ns access	-15					
• Packages						

1 dekages	
36-pin SOJ (400 mil)	J

Temperature
Commercial
None

Industrial

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GENERAL DESCRIPTION

The GVT73512A8 is organized as a 524,288 x 8 SRAM using a four-transistor memory cell with a high performance, silicon gate, low-power CMOS process. Galvantech SRAMs are fabricated using double-layer polysilicon, double-layer metal technology.

This device offers center power and ground pins for improved performance and noise immunity. Static design eliminates the need for external clocks or timing strobes. For increased system flexibility and eliminating bus contention problems, this device offers chip enable (CE#) and output enable (OE#) with this organization.

Writing to these devices is accomplished when write enable (WE#) and chip enable (CE#) inputs are both LOW. Reading is accomplished when (CE#) and (OE#) go LOW with (WE#) remaining HIGH. The device offers a low power standby mode when chip is not selected. This allows system designers to meet low standby power requirements.

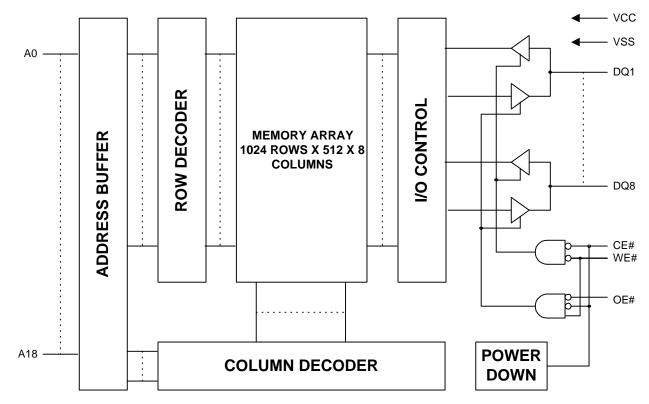
	_	SIGNMENT Pin SOJ	
A0 A1 A2 A3 A4 CE# DQ1 DQ2 VCC VSS DQ3 DQ4 WE# A5	_		NC A18 A17 A16 A15 OE# DQ8 DQ7 VSS VCC DQ6 DQ5 A14 A13
A6 A7	15 16	22 21	A12 A11
	9		A11 A10
A9	18	19	NC

 $(0^{\circ}C \text{ to } 70^{\circ}C)$

 $(-40^{\circ}C \text{ to } 85^{\circ}C)$

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FUNCTIONAL BLOCK DIAGRAM



TRUTH TABLE

MODE	CE#	WE#	OE#	DQ	POWER
READ	L	Н	L	Q	ACTIVE
WRITE	L	L	Х	D	ACTIVE
OUTPUT DISABLE	L	Н	Н	HIGH-Z	ACTIVE
STANDBY	Н	Х	Х	HIGH-Z	STANDBY

PIN DESCRIPTIONS

SOJ Pin Numbers	SYMBOL	TYPE	DESCRIPTION			
1, 2, 3, 4, 5, 14, 15, 16, 17, 18, 20, 21, 22, 23, 24, 32, 33, 34, 35	A0-A18	Input	Addresses Inputs: These inputs determine which cell is addressed.			
13	WE#	Input	Write Enable: This input determines if the cycle is a READ or WRITE cycle. WE# is LOW for a WRITE cycle and HIGH for a READ cycle.			
6	CE#	Input	Chip Enable: This active LOW input is used to enable the device. When CE# is LOW, the chip is selected. When CE# is HIGH, the chip is disabled and automatically goes into standby power mode.			
31	OE#	Input	Output Enable: This active LOW input enables the output drivers.			
7, 8,11, 12, 25, 26, 29, 30	DQ1-DQ8	Input/Output	SRAM Data I/O: Data inputs and data outputs			
9, 27	VCC	Supply	Power Supply:3.3V ±0.3V			
10, 28	VSS	Supply	Ground			

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ABSOLUTE MAXIMUM RATINGS*

Voltage on VCC Supply Relative to VSS0	0.5V to +4.6V
V _{IN} 0.5V t	o VCC+0.5V
Storage Temperature (plastic)	
Junction Temperature	+125°
Power Dissipation	1.2W
Short Circuit Output Current	50mA

*Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC ELECTRICAL CHARACTERISTICS AND RECOMMENDED OPERATING CONDITIONS

(All Temperature Ranges; VCC = $3.3V \pm 0.3V$ unless otherwise noted)

DESCRIPTION	CONDITIONS	SYMBOL	MIN	МАХ	UNITS	NOTES
Input High (Logic 1) voltage		V _{IH}	2.2	VCC+0.5	V	1, 2
Input Low (Logic 0) Voltage		V _{II}	-0.5	0.8	V	1, 2
Input Leakage Current	0V ≤ V _{IN} ≤ VCC	IL	-5	5	uA	
Output Leakage Current	Output(s) disabled, $0V \le V_{OUT} \le VCC$	IL _O	-5	5	uA	
Output High Voltage	I _{OH} = -4.0mA	V _{OH}	2.4		V	1
Output Low Voltage	I _{OL} = 8.0mA	V _{OL}		0.4	V	1
Supply Voltage		VCC	3.0	3.6	V	1

DESCRIPTION	CONDITIONS	SYM	TYP	-10	-12	-15	UNITS	NOTES
Power Supply Current: Operating	Device selected; CE# \leq V _{IL} ; VCC =MAX; f=f _{MAX} ; outputs open	lcc	90	240	210	175	mA	3, 14
TTL Standby	CE# ≥V _{IH} ; VCC = MAX; f=f _{MAX}	I _{SB1}	30	85	80	70	mA	14
CMOS Standby	CE1# \geq VCC -0.2; VCC = MAX; all other inputs \leq VSS +0.2 or \geq VCC -0.2; all inputs static; f= 0	I _{SB2}	0.1	10	10	10	mA	14

CAPACITANCE

DESCRIPTION	CONDITIONS	SYMBOL	МАХ	UNITS	NOTES
Input Capacitance	T _A = 25°C; f = 1 MHz	CI	6	pF	4
Input/Output Capacitance (DQ)	VCC = 3.3V	C _{I/O}	8	pF	4

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AC ELECTRICAL CHARACTERISTICS

(Note 5) (All Temperature Ranges; VCC = $3.3V \pm 0.3V$)

DECODIDION		-	10	- '	12	2 - 15			
DESCRIPTION	SYM	MIN	MAX	MIN	MAX	MIN	MAX	UNITS	NOTES
READ Cycle	n.					1			
READ cycle time	^t RC	10		12		15		ns	
Address access time	^t AA		10		12		15	ns	
Chip Enable access time	^t ACE		10		12		15	ns	
Output hold from address change	^t OH	3		3		3		ns	
Chip Enable to output in Low-Z	^t LZCE	3		3		3		ns	4, 7
Chip disable to output in High-Z	^t HZCE		5		6		7	ns	4, 6, 7
Output Enable access time	^t AOE		5		6		7	ns	
Output Enable to output in Low-Z	^t LZOE	0		0		0		ns	
Output Enable to output in High-Z	^t HZOE		5		6		7	ns	4, 6
Chip Enable to power-up time	^t PU	0		0		0		ns	4
Chip disable to power-down time	^t PD		10		12		15	ns	4
WRITE Cycle									
WRITE cycle time	^t WC	10		12		15		ns	
Chip Enable to end of write	^t CW	8		8		9		ns	
Address valid to end of write, with OE# HIGH	^t AW	8		8		9		ns	
Address setup time	^t AS	0		0		0		ns	
Address hold from end of write	^t AH	0		0		0		ns	
WRITE pulse width	^t WP2	10		10		11		ns	
WRITE pulse width, with OE# HIGH	^t WP1	8		8		9		ns	
Data setup time	^t DS	5		6		7		ns	
Data hold time	^t DH	0		0		0		ns	
Write disable to output in Low-Z	^t LZWE	3		4		5		ns	4, 7
Write Enable to output in High-Z	^t HZWE		6		6		7	ns	4, 6, 7

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AC TEST CONDITIONS

Input pulse levels	0V to 3.0V
Input rise and fall times	1.5ns
Input timing reference levels	1.5V
Output reference levels	1.5V
Output load	See Figures 1 and 2

OUTPUT LOADS

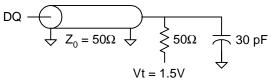


Fig. 1 OUTPUT LOAD EQUIVALENT

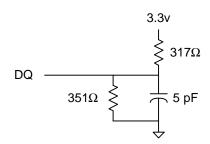


Fig. 2 OUTPUT LOAD EQUIVALENT

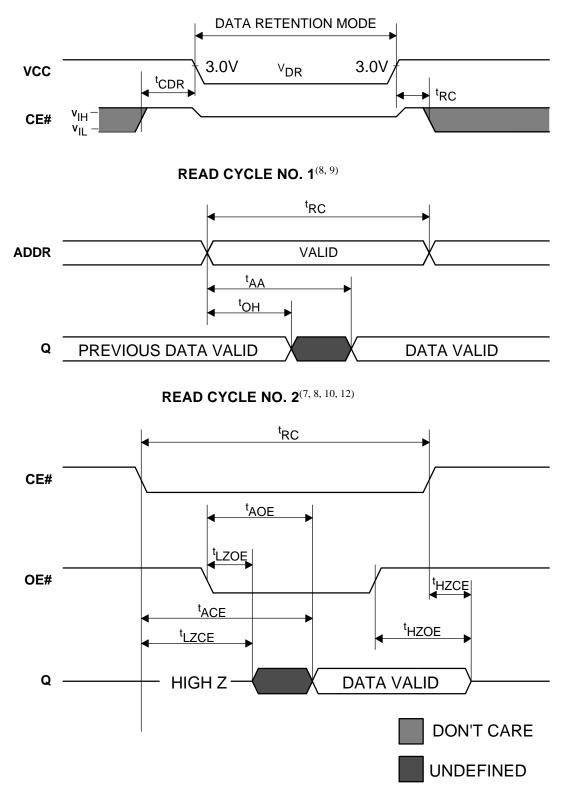
- 8. WE# is HIGH for READ cycle.
- 9. Device is continuously selected. Chip enable and output enables are held in their active state.
- 10. Address valid prior to, or coincident with, latest occurring chip enable.
- 11. t_{RC} = Read Cycle Time.
- 12. Chip Enable and Write Enable can initiate and terminate a WRITE cycle.
- 13. Capacitance derating applies to capacitance different from the load capacitance shown in Fig. 1.
- 14. Typical values are measured at 3.3V, 25°C and 20ns cycle time.

NOTES

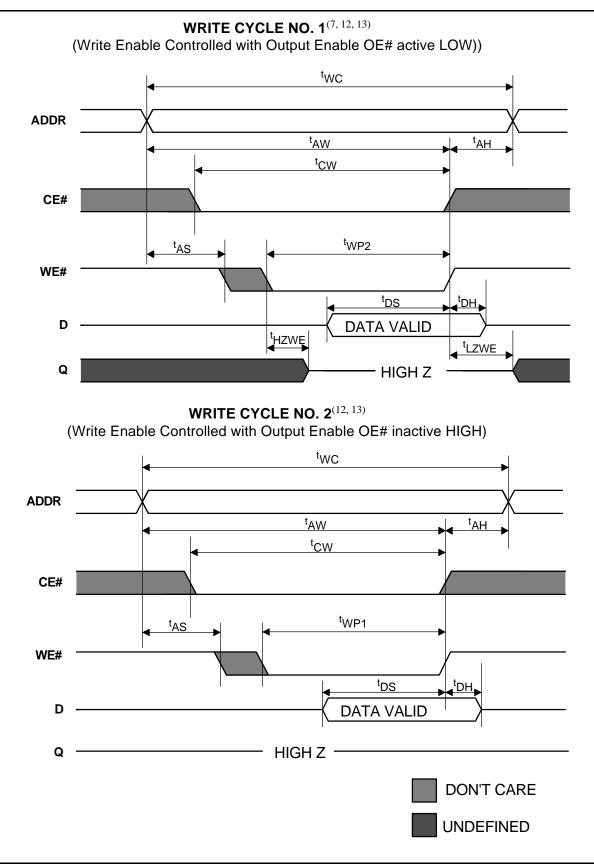
- 1. All voltages referenced to VSS (GND).
- 2. Overshoot: $V_{IH} \le +6.0V$ for $t \le {}^{t}RC/2$. Undershoot: $V_{IL} \le -2.0V$ for $t \le {}^{t}RC/2$
- 3. I_{cc} is given with no output current. I_{cc} increases with greater output loading and faster cycle times.
- 4. This parameter is sampled.
- 5. Test conditions as specified with the output loading as shown in Fig. 1 unless otherwise noted.
- 6. Output loading is specified with $C_L=5pF$ as in Fig. 2. Transition is measured $\pm 500mV$ from steady state voltage.
- At any given temperature and voltage condition, ^tHZCE is less than ^tLZCE and ^tHZWE is less than ^tLZWE.

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LOW VCC DATA RETENTION WAVEFORM



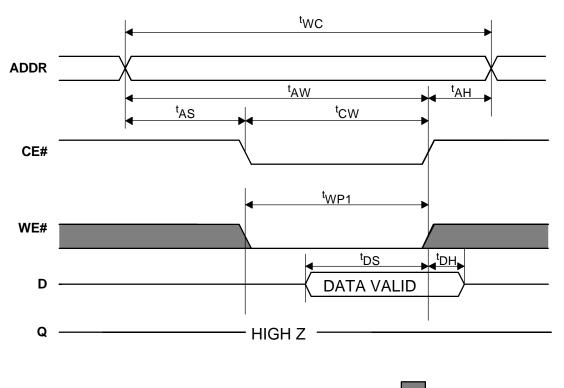
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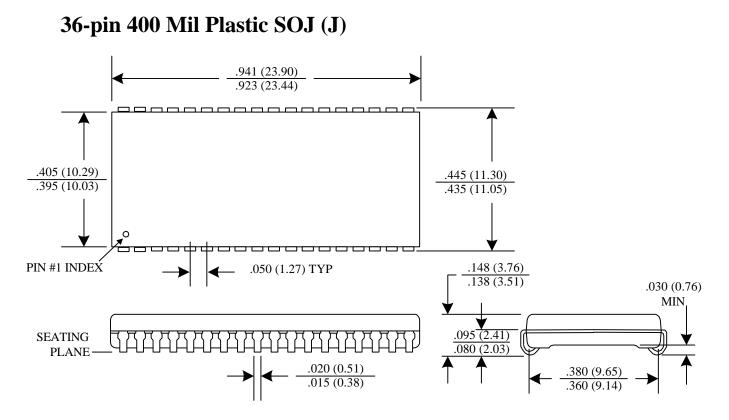
WRITE CYCLE NO. 3^(12, 13) (Chip Enable Controlled)



DON'T CARE

GVT73512A8 REVOLUTIONARY PINOUT 512K X 8

Package Dimensions



Note: All dimensions in inches (millimeters) $\frac{MAX}{MIN}$ or typical, min where noted.

Ordering Information

